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W. DANIEL SWAYZE, JR. TEXAS INSTRUMENTS INCORPORATED PO BOX 655474, M/S 3999 DALLAS, TX 75265 MAR 1 3 2006 MAR							
APPLICATION NO.	FILING DATE	FIDOT NAME	D ADVENTOR	<u> </u>	106	(Date)	
10/612,129	7/2/2003	FIRST NAMED INVENTOR Chee K. Yew			TI-26239.1	CONFIRMATION NO. 3928	
TITLE OF INVENTION: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE							
APPLN. TYPE	SMALL ENTITY	ISSUE FEE	PUBLICATIO	NEEE	TOTAL CECION DUE	T	
nonprovisional	NO	\$1400	\$300	WIEC	TOTAL FEE(S) DUE \$1700	03/28/2006	
EXAMIN	150						
Cao, Ph		2814	CLASS-SUB 257-668				
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

First Inventor: Yew

Docket Number: TI-26239.1

Total Pages Sent: 2

Serial No.: 10/612,129

Art Unit: 2814

Filed: 7/2/2003

Examiner: Cao, Phat X.

For:

DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE

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NAME OF INVENTOR(S): Yew TITLE OF INVENTION: DIRECT ATTACHMENT OF CHIP TO ORGANIC SUBSTIFILE NO: TI-26239.1 FAXED: 3/3706 DUE: 3/38/2006 ATTY/SECY:WDS/srt	OF SEMICONDUCTOR STRATE DEPOSIT ACCT. NO.: 20-0668	RECEIPT DATE & SERIAL NO.: Serial No.: 10/612,129 Filing Date: 7/2/2003			

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